

ATLAS

Toronto Group Meeting 25th June 2007

Status: LHC, ATLAS

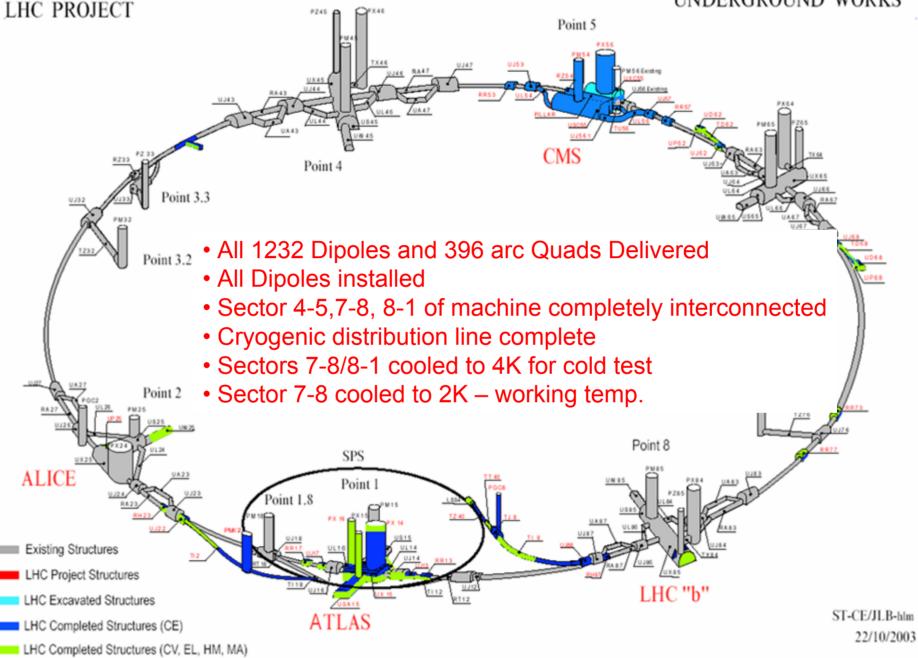
Next Two Years

Next Five - Ten Years

Next Ten - Twenty Years

R. S. Orr

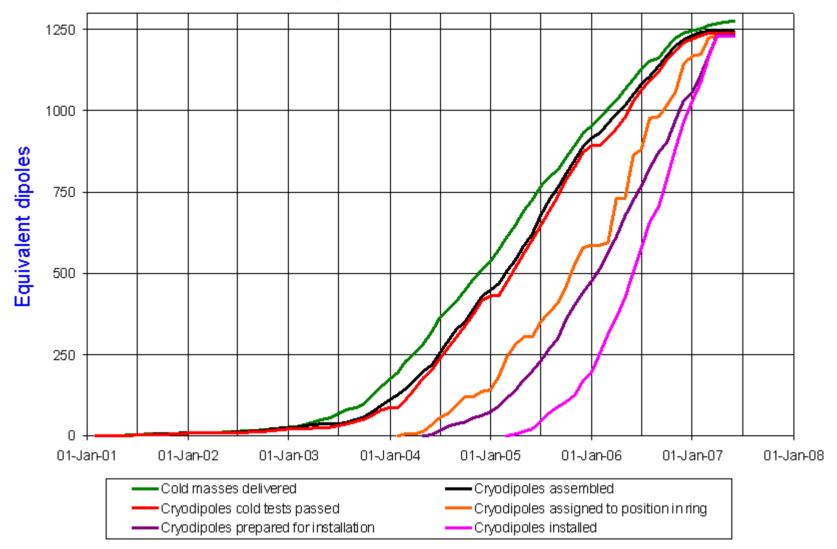








Cryodipole overview



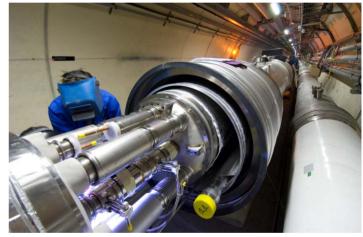
Updated 31 May 2007

Data provided by D. Tommasini AT-MCS, L. Bottura AT-MTM

Underground Last Dipole April 2007

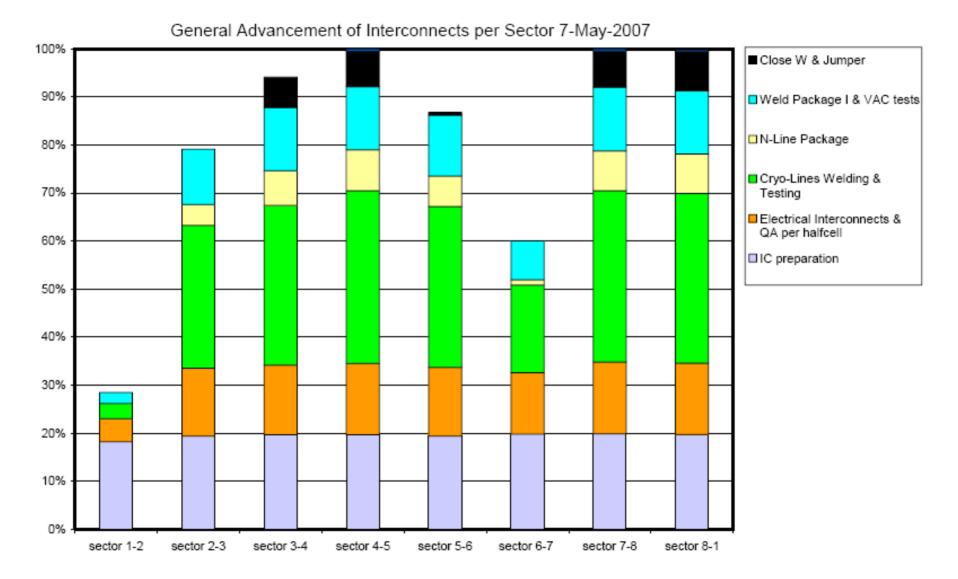






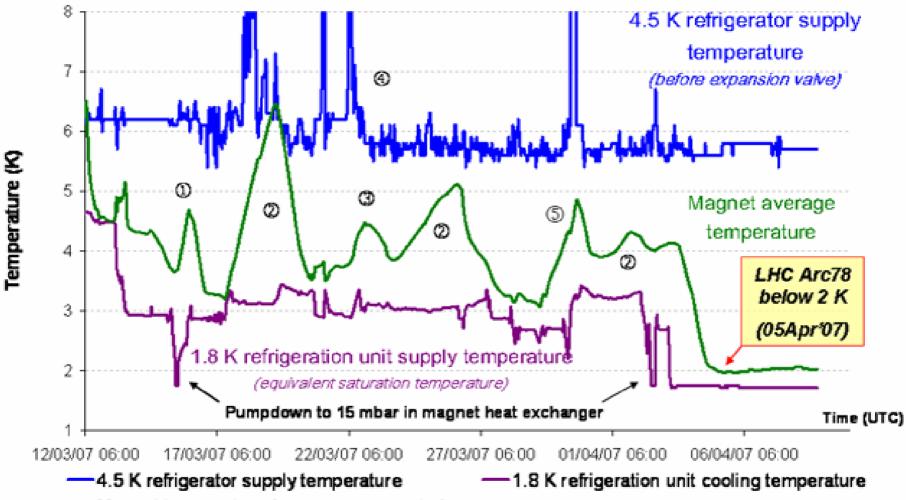


Magnet Interconnections









Magnet temperature (average over sector)

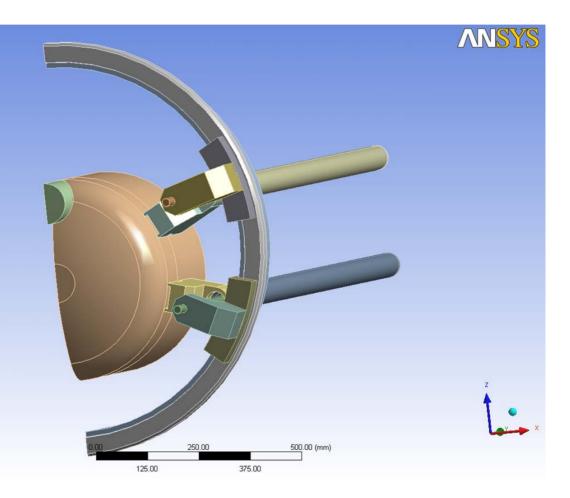
- O Tuning of cold compressors & turbines with temporary stop of magnet cooling
- O Stop of active cooling in weekend with only on call activity limited to secure hardware
- ③ Stop of magnet cooling for logic improvement in 1.8K refrigeration unit
- @ Random emergency stop in cryogenic surface building with stop of sector 78 cooling
- S micro-electrical stop followed by utility stops

Inner Triplet: Cold Mass

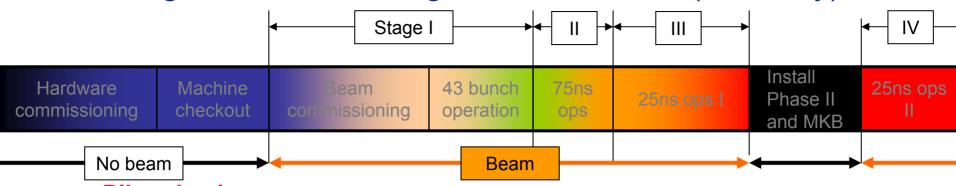


Repair Cartridge

- Affixed at Q1 non-IP end and at Q3 IP end
- Transfer load at all temperatures
- Limits support deflections
- Compound design with Invar rod and aluminium alloy tube
- Attached with brackets to cold mass and cryostat outer vessel



Staged Commissioning Plan for Protons (R. Bailey)



Pilot physics run

- First collisions
- 43 bunches, no crossing angle, no squeeze, moderate intensities
- Push performance (156 bunches)
- *Performance limit* 10³² cm⁻² s⁻¹ (event pileup)

75ns operation

- Establish multi-bunch operation, moderate intensities
- Relaxed machine parameters (squeeze and crossing angle
- Push squeeze and crossing angle
- Performance limit 10³³ cm⁻² s⁻¹ (event pileup)

25ns operation I

- Nominal crossing angle
- Push squeeze
- Increase intensity to 50% nominal
- Performance limit 2 10³³ cm⁻² s⁻¹

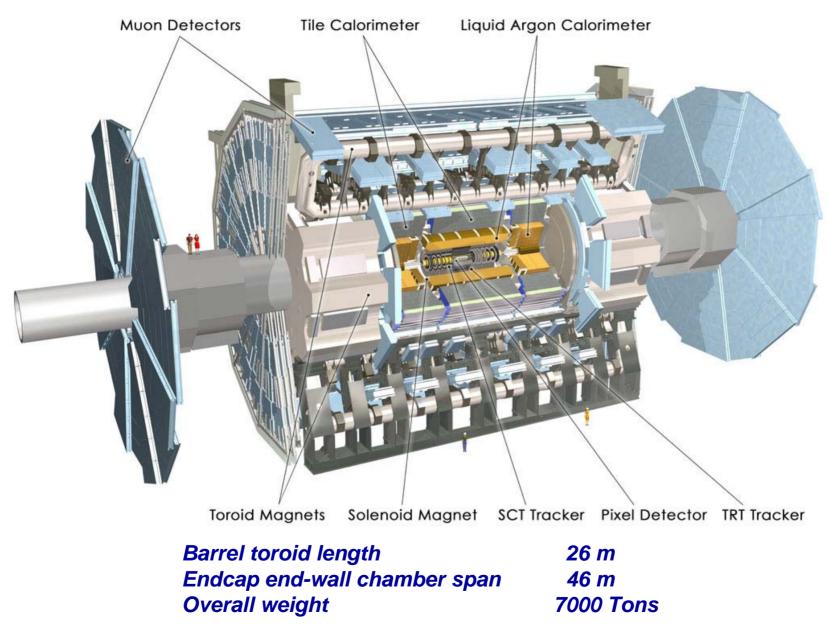
25ns operation II

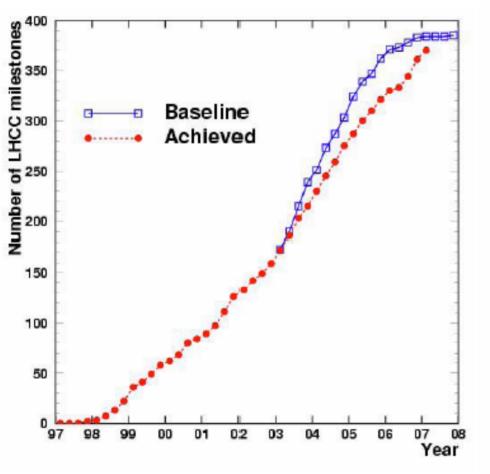
Push towards nominal performance

General Schedule

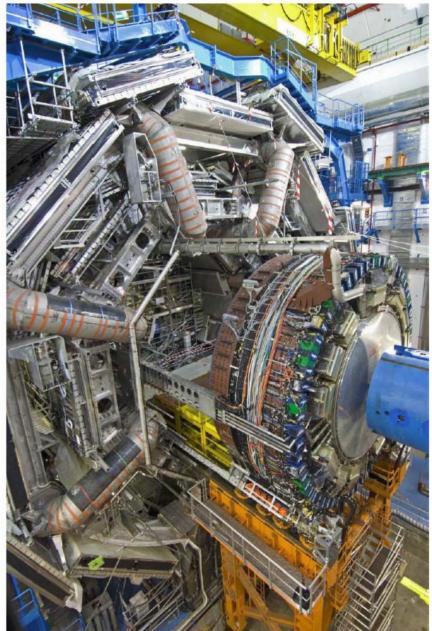
- Dec 2007 engineering run not possible delays in installation and equipment commissioning.
- Schedule being reassessed, accounting for inner triplet repairs and their impact on sector commissioning
 - All technical systems commissioned to 7 TeV operation, and machine closed April 2008
 - Beam commissioning starts May 2008
 - First collisions at 14 TeV c.m. July 2008
 - Pilot run pushed to 156 bunches for reaching 10³² cm⁻².s⁻¹ by end 2008
 - winter 2008-09 shutdown to complete collimation system and dilution kickers, thus allowing high intensity operation
- No provision in schedule for major mis-haps, e.g. additionnel warm-up/cool-down of sector

Construction Status of ATLAS Detector Systems





Integrated LHCC milestones LHCC April 2007



LHC Prospects

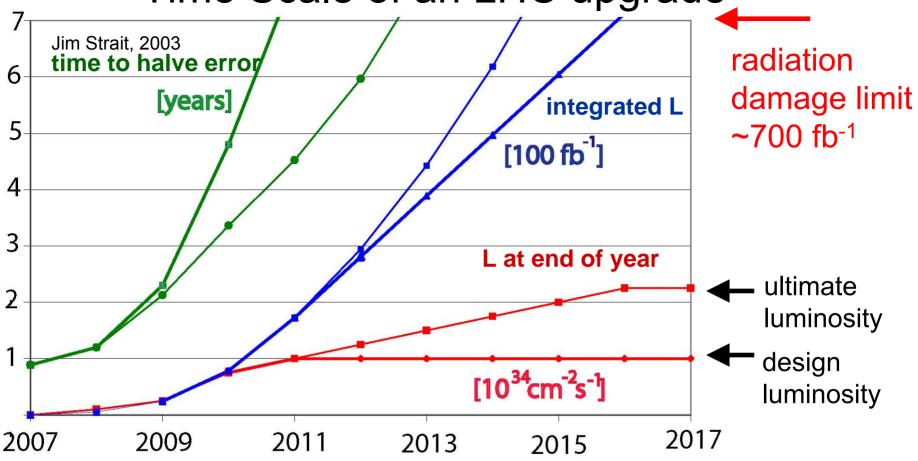
- Date for first beams/collisions: ⇒ July 2008
- Initial physics run starts in summer/fall 2008
 ⇒ collect ~10 fb⁻¹ /exp (2.10³³cm⁻² s⁻¹) by end of 2009
- Depending on the evolution of the machine...
 - \Rightarrow collect 200-300 fb⁻¹/exp (3.4-10.10³³cm⁻² s⁻¹) in 5-6 years time

Already time to think of upgrading the machine

Two options presently discussed/studied

- Higher luminosity ~10³⁵cm⁻² s⁻¹ (SLHC)
 - Needs changes in machine and particularly in the detectors
 - \Rightarrow Start change to SLHC mode some time 2012-2014
 - \Rightarrow Collect ~3000 fb⁻¹/experiment in 3-4 years data taking.
- Higher energy?
 - LHC can reach \sqrt{s} = 15 TeV with present magnets (9T field)
 - \sqrt{s} of 28 (25) TeV needs ~17 (15) T magnets ⇒ R&D + MCHf needed

Time Scale of an LHC upgrade



- Life expectancy of LHC IR quadrupole magnets is estimated to be <10 years due to high radiation doses
- Statistical error halving time exceeds 5 years by 2011-2012 → it is reasonable to plan a machine luminosity upgrade based on new low-β IR magnets around ~2014-2015

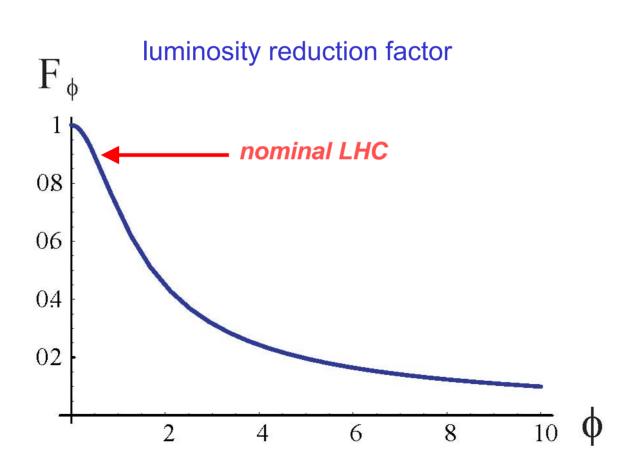
Machine Upgrade in Stages

- <u>Push</u> LHC performance *without* new hardware – luminosity $\rightarrow 2.3 \times 10^{34}$ cm⁻²s⁻¹, E_b =7 \rightarrow 7.54 TeV
- LHC IR upgrade
 - replace low- β quadrupoles after ~7 years peak luminosity \rightarrow 4.6x10³⁴ cm⁻²s⁻¹
- LHC injector upgrade
 - peak luminosity \rightarrow 9.2x10³⁴ cm⁻²s⁻¹
- LHC energy upgrade
 - $E_b \rightarrow 13 21 \text{ TeV} (15 \rightarrow 24 \text{ T dipole magnets})$

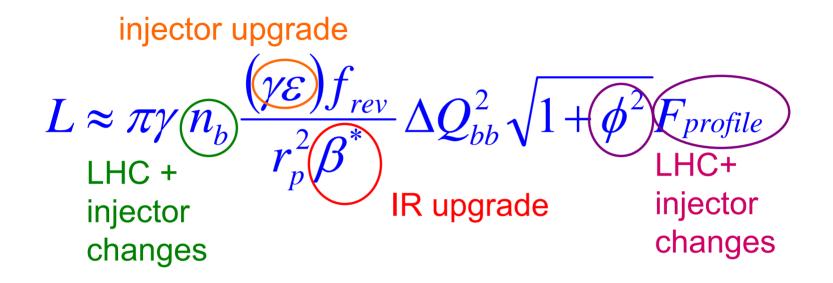
Nominal Crossing Angle "at the edge"

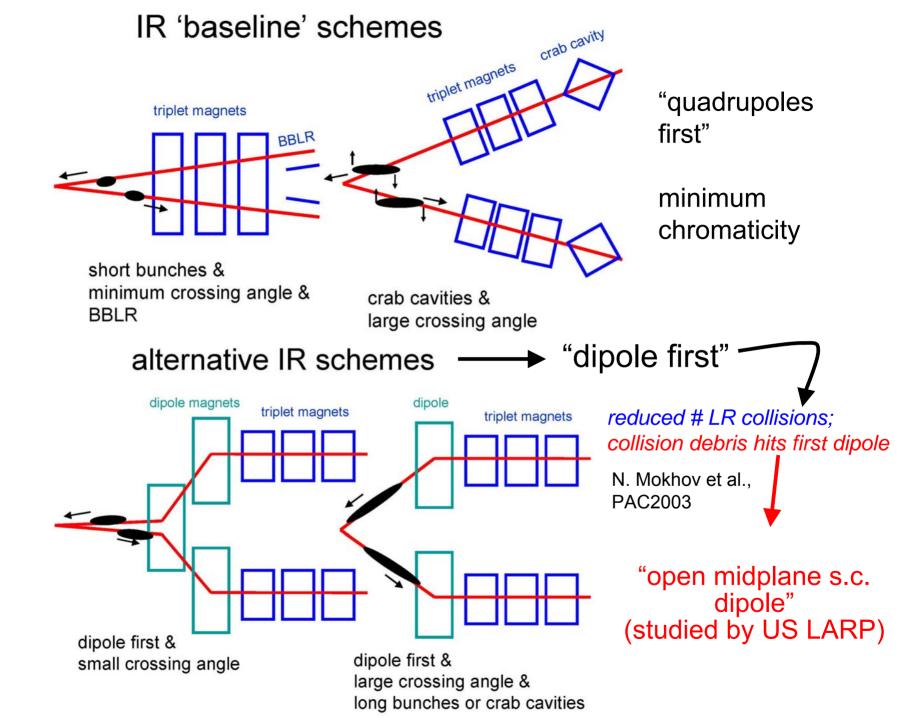
$$F_{\phi} = \frac{1}{\sqrt{1 + \phi^2}}; \quad \phi \equiv \frac{\theta_c \sigma_z}{2\sigma_x}$$

Piwinski angle

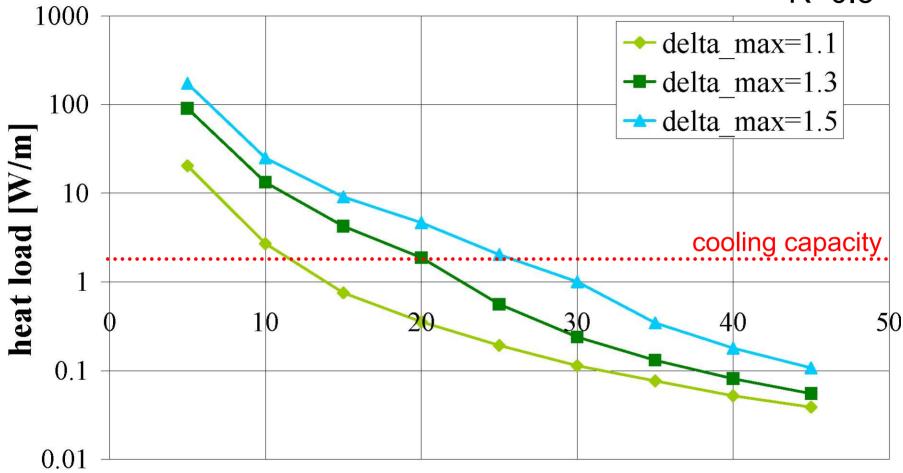


Beam-Beam Limit Luminosity Equation





arc heat load vs. spacing, $N_b = 1.15 \times 10^{11}$, 'best' model heat load R=0.5



bunch spacing [ns]

Summary of Luminosity Upgrade

Scenarios for $L \sim 10^{35} cm^{-2} s^{-1}$ with acceptable heat load and events/crossing

<u>25-ns:</u> push β^* to limit

- Slim magnets inside detector
- Crab Cavities
- High Gradient, Large Aperture Nb_3Sn Quads

50-ns: Fewer bunches, higher charge

- Realizable with NbTi
- Beam-Beam tune shift due to large Piwinski angle?
- Luminosity leveling via bunch length and β^* tuning

LHC Energy Doubler 14*14 TeV

Dipoles: B_{nom}=16.8T, B_{design}=19T

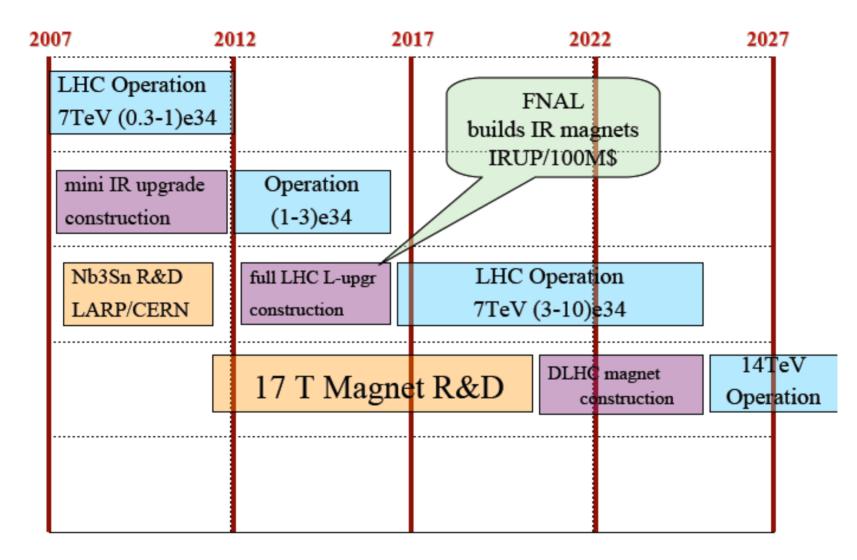
- Superconductor *Nb*₃*Sn*
- 16T demonstrated at 4K
- 10 years for R&D, 10 years production
- 3G\$

LHC Energy Tripler 21*21 TeV

Dipoles: B_{nom}=25T, B_{design}=29T

- Superconductor HTS-BSCCO or *Nb*₃*Sn*
- Well above demonstrated Nb_3Sn
- 20++ years for R&D, ? years production
- ?G\$

LHC, sLHC, DLHC perspective



Physics Case for the SLHC

The use/need for for the SLHC will obviously depend on how EWSB and/or the new physics will manifest itself

This will only be answered by LHC itself

What will the HEP landscape look like in 2012??

Rough expectation for the SLHC versus LHC

- Improvement of SM/Higgs parameter determination
- Improvement of New Physics parameter determinations, if discovered
- Extension of the discovery reach in the high mass region
- Extension of the sensitivity of rare processes

Extending the Physics Potential of LHC

Electroweak Physics

- production of multiple gauge bosons ($n_v \ge 3$)
- triple and quartic gauge boson couplings
- top quarks/rare decays
- Higgs physics
 - rare decay modes
 - Higgs couplings to fermions and bosons
 - Higgs self-couplings
 - Heavy Higgs bosons of the MSSM
- Supersymmetry
- Extra Dimensions
 - Direct graviton production in ADD models



CERN-TH/2002-078 hep-ph/0204087 April 1, 2002

PHYSICS POTENTIAL AND EXPERIMENTAL CHALLENGES OF THE LHC LUMINOSITY UPGRADE

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Include pile up, detector

- Resonance production in Randall-Sundrum models TeV⁻¹ scale models
- Black Hole production
- Quark substructure
- Strongly-coupled vector boson system
 - $W_L Z_L g W_L Z_L$, $Z_L Z_L$ scalar resonance, $W_L^+ W_L^+$
- New Gauge Bosons

Preliminary...

Indicative Physics Reach

Units are TeV (except W_LW_L reach)

Ellis, Gianotti, ADR hep-ex/0112004+ updates

[®]Ldt correspond to <u>1 year of running</u> at nominal luminosity for <u>1 experiment</u>

	LHC	SLHC	SLHC	LinCol	LinCol
PROCESS	14TeV	14TeV	28TeV	0.8 TeV	5 TeV
	100 fb ⁻¹	1000 fb ⁻¹	100 fb ⁻¹	500 fb ⁻¹	100 fb ⁻¹
Squarks	2.5	3	4	0.4	2.5
W _L W _L	2σ	4σ	4.5σ		
Z	5	6	8	8†	8†
Extra Dim (δ=2)	9	12	15	5 - 8.5†	30 - 55†
q*	6.5	7.5	9.5	0.8	5
Λ_{comp}	30	40	40	100	400
TGC (λ _γ)	0.0014	0.0006	0.0008	0.0004	0.00008

† indirect reach
(from precision measurements)

Approximate mass reach machines:

 $\sqrt{s} = 14 \text{ TeV}, \ L=10^{34} (LHC)$: up to ≈ 6.5 TeV $\sqrt{s} = 14 \text{ TeV}, \ L=10^{35} (SLHC)$: up to ≈ 8 TeV $\sqrt{s} = 28 \text{ TeV}, \ L=10^{34}$: up to ≈ 10 TeV

Detectors: General Considerations

	1	1	1
	LHC	SLHC	
√s L Bunch spacing ∆t	14 TeV 10 ³⁴ 25 ns	14 TeV 10 ³⁵ 25/50 ns	
σ_{pp} (inelastic) N. interactions/x-ing (N=L $\sigma_{pp} \Delta t$)	~ 80 mb ~ 20	~ 80 mb ~ 280/350	
dN _{ch} /dη per x-ing <e<sub>T> charg. particles</e<sub>	~ 150 ~ 450 MeV	~ 2000/2500 ~ 450 MeV	Normalised to LHC values.
Tracker occupancy Pile-up noise in calo Dose central region	1 1 1	10/20 ~9 10	10 ⁴ Gy/year R=25 cm

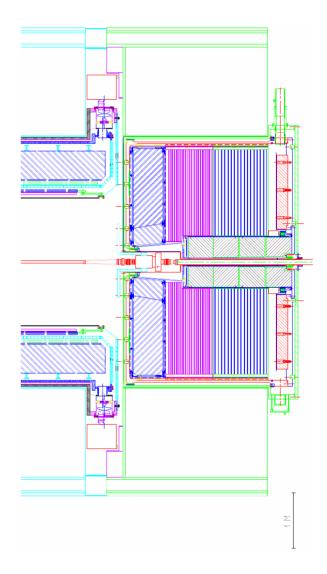
In a cone of radius = 0.5 there is $E_T \sim 200 \text{GeV}$. This will make low E_t jet triggering and reconstruction difficult.

Detector Upgrade

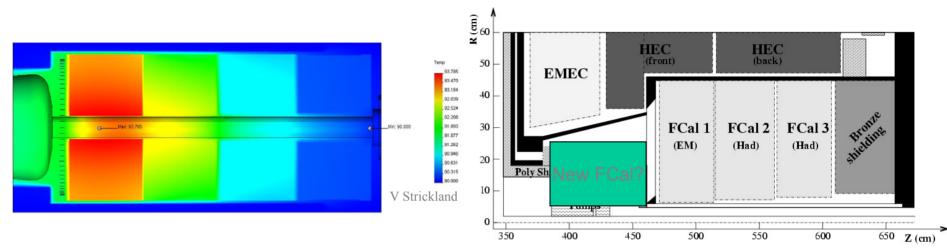
- ATLAS has begun studying what needs to be upgraded for 10³⁵cm⁻²s⁻¹ instantaneous luminosity
 - ~10× harsher pileup, radiation environment
 - Also constrained by existing detector: what can be moved/stored where/when
- Major ID overhaul foreseen
 - TRT replaced by Si Strips
 - Pixels move to larger radius
 - New technology for innermost layers
- Calorimeters
 - New FE electronics for HEC
 - New cold or warm FCAL
 - Opening endcap cryostat implies a long installation schedule (~2-3 years)
- Schedule to fit 2016 timescale
 - Aim for upgrade TDR in 2010 to allow adequate procurement/construction
- Also Trigger, FE in general, etc.. etc.. etc...

LAr Calorimeters at sLHC - Overview

- Critical issues
 - ion build up and heat load
- The HiLum ATLAS Endcap Project
- Radiation hardness:
 - R&D for HEC cold electronics;



FCal - Heatload

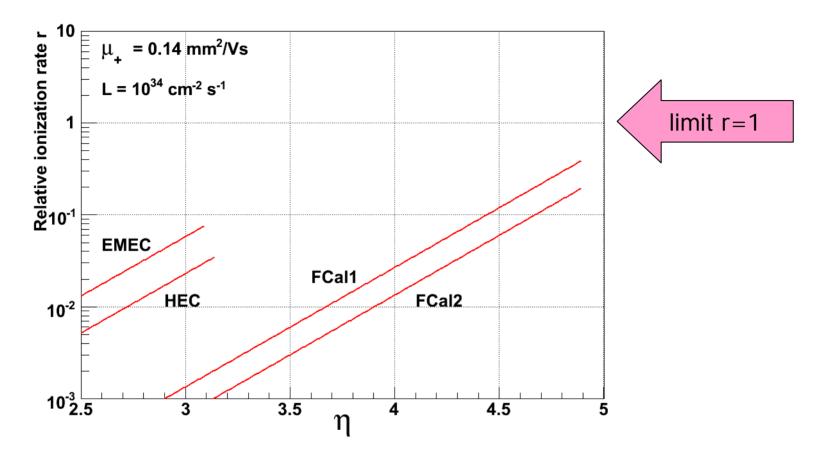


- Simulation of LAr FCAL beam heating
 - Maximum temperature 93.8K enough to boil LAr
- Uncertainties convection could make things better or worse; other endcap calorimeters also implicated
- Improve FCAL cooling (open endcap cryostat)

- ~2-3 year round-trip - big timing challenge

New "warm" FCAL plug?

+ve Ion Buildup – Distorts Electric Field



- EMEC and HEC OK
- FCAL: reduce gap from 250 μ to 100 μ \rightarrow all endcap calorimeters stay in region r < 1

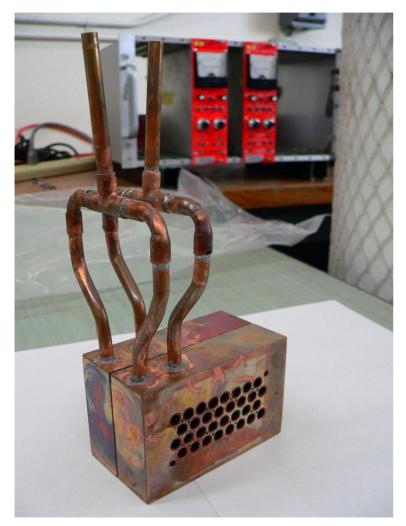
sLHC

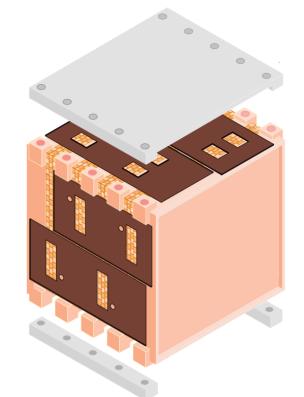
HiLum ATLAS Endcap Project

- Goal: establish limitations on the operation of the endcap calorimeters (FCAL, EMEC, HEC) at highest LHC luminosities.
- R&D: 'mini modules' of FCAL, EMEC and HEC type, each in one separate cryostat;
- IHEP Protvino: beam line # 23: from 10^7 up to 10^{12} p/spill; E= 60/70 GeV;
- Arizona, Dresden, JINR Dubna, Kosice, Mainz, LPI Moscow, MPI Munich, BINP Novosibirsk, IHEP Protvino, TRIUMF, Wuppertal.

HiLum Test Modules

FCAL module



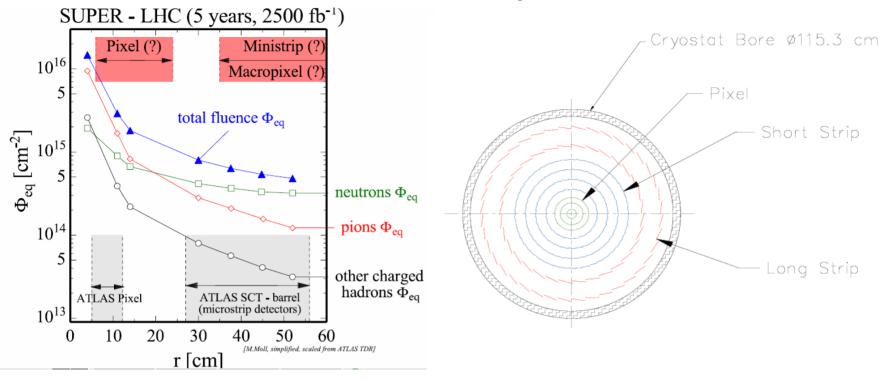


- 4 'standard' HEC gaps (HEC1)
- 4 read-out channels
- 4 HV lines (one per subgap)

HEC Electronics Upgrade

- HEC is equipped with cold electronics based on GaAs ASICs.
 - LHC expect in 10 years neutron fluence of $0.2\times10^{14}\ n/cm^2$
 - Degradation of performance sets in at typically 3×10^{14} n/cm^2
 - Aim for factor of 10 improvement
- Electronics upgrade R&D (Montréal, MPI, Kosice, TRIUMF) four options.
 - 1. Existing chips for sLHC conditions.
 - 2. Re-design ASIC with present GaAs technology
 - 3. Investigate SiGe HBT (Heterojunction Bipolar Transistor)
 - 4. Study warm electronics options: Si (or SiGe) warm preamps
- TRIUMF is contributing to options 2,3,4
 - Schematics development and simulation
 - Validation tests
 - System tests
 - Technical manpower

Inner Detector Replacement



- Order of magnitude increase in Data rates, Occupancy, Irradiation
- No TRT Si strips
- Pixels moved to larger radius
- New technology for inner layers
- R&D required on sensors, readout, and mechanical engineering

Pixel-layer Technologies

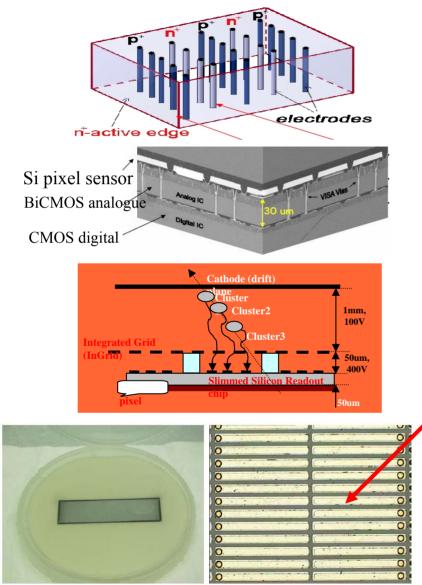
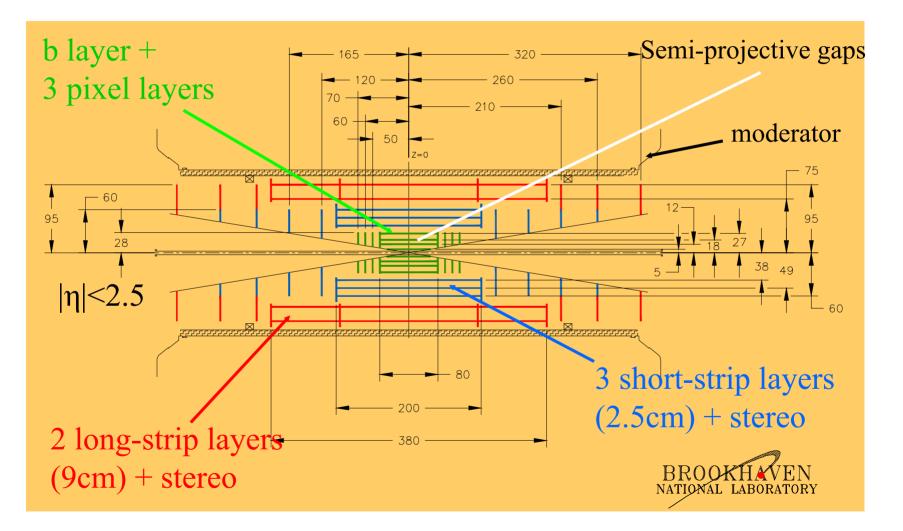


Figure 5: (a) Photograph of the ATLAS pixel diamond mounted in the carrier ready for bump bonding. (b) Zoom view of the pixel pattern after the under-bump metal is deposited.

- Harshest radiation environment (R~4cm)
 - investigate new technologies
- 3D Si
- Thin silicon + 3D interconnects
- Gas over thin pixel (GOSSIP)
- Diamond pixels
- May test in pre-SLHC b-layer replacement (~2012)

xiard hysics

Strawman Layout of Tracker



Schedule

Strawman & options fixed ID R&D, conceptual design TDR ID cooling PRR Silicon sensor PRR ID FE electronics PRR **b-layer replacement** Procure parts, component assembly Start surface assembly Stop data taking Remove old detectors, install new Data

Dec 2006 2007-2009 Feb 2010 **April 2010 July 2010** Oct 2010 **Ready 2012** 2010-2012 March 2012 Sep 2014 2014-2015 **April 2016**

Tracker Upgrade work in Canada

Diamond Sensors – Toronto, Carleton, Montréal +.....

- Prove radiation tolerance of pCVD diamond pixel prototypes
- Industrialize bump-bonding
- FE electronics
- Mechanical structure
- Test beam program 2008-2009

Electronics – Carleton, UBC, York, TRIUMF +....

- FE ASICS Si FE module controller
 - Initially FPGA, Move to ASIC
- Contribute to system design develop expertise
- Backend (eg RODs) later in upgrade path
- TRIUMF Technical manpower

Bottom Line

- LHC with Luminosity upgrade will likely be built.
 - Work in Canada needs to start soon
 - Scope for new people and new ideas

MACHINE EXTRAS

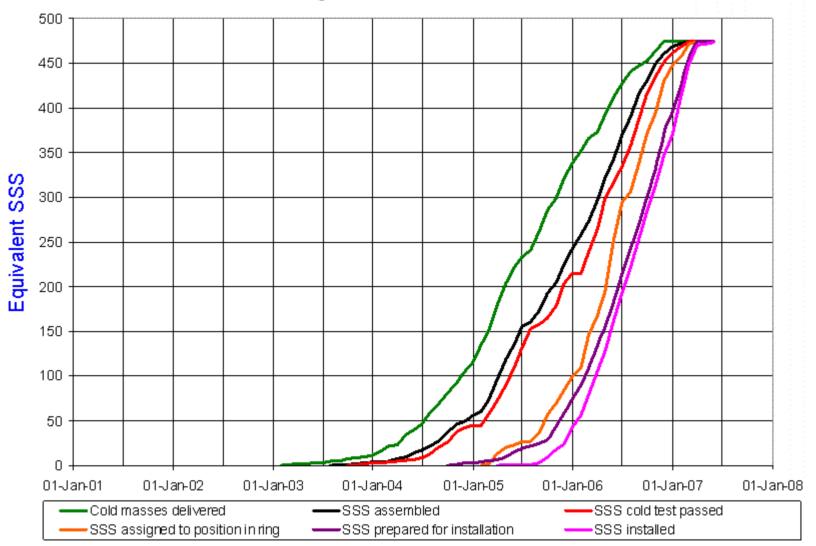
MACHINE EXTRAS

MACHINE EXTRAS





Short Straight Section Overview



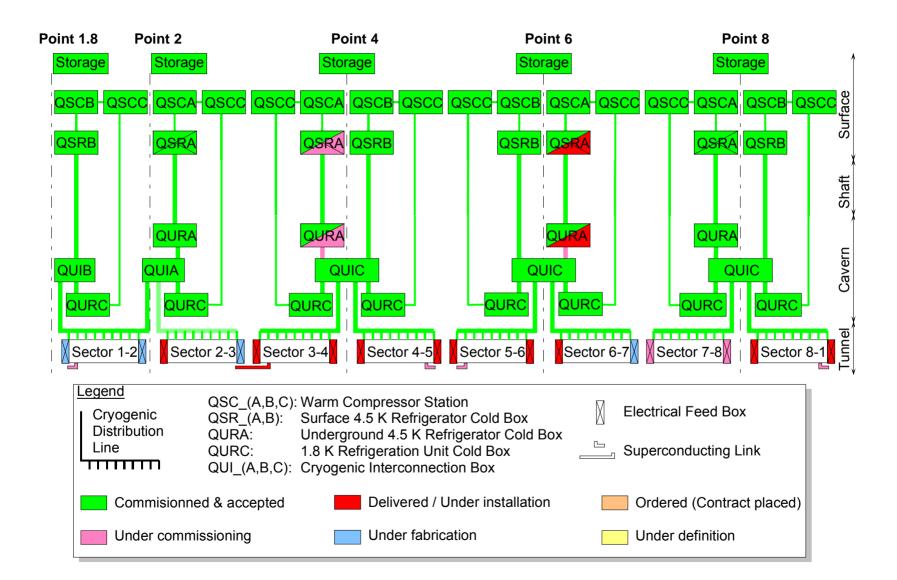
Updated 31 May 2007

Data provided by M. Modena AT-MCS, L. Bottura AT-MTM

Inner Triplet Problem March 2007

- During the pressure test of the repaired triplet in 5L (27 March 2007), longitudinal fixed points on the "spider" supports of the cold mass broke at 20 bar.
- Loading conditions resulting from such pressure forces not taken into account in the design
- A complete review of the mechanical design of the Inner Triplets was conducted at CERN (24-25 April 2007) - repair solutions based on contraction-compensated compound metallic columns transfering longitudinal pressure forces onto the cryostat outer vessels
- Detailed design and validation of this solution are under way, and an implementation schedule is being established

Cryogenic System Overview

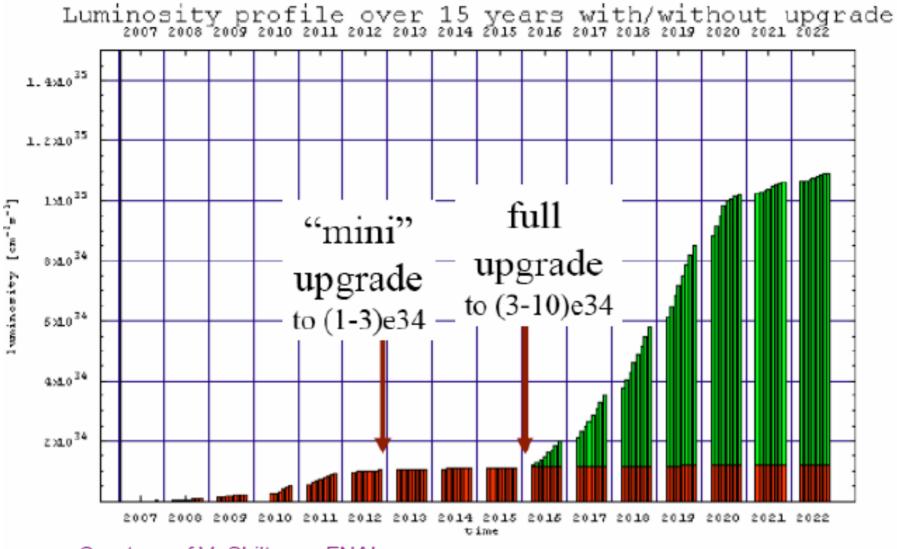


Machine upgrade

parameter	nom.	ult.	upgr	ades	
no. of bunches n_b	2808	2808	2808	1	
rms bunch length	7.6	7.6	7.6,	7500	Latest parameter
σ_z [cm]			4.2		set:
rms energy spread	1.1	1.1	1.1,	5.8	F. Ruggiero et al.
$\sigma_{\delta} [10^{-4}]$			3.7		PAC2003 report
beta at IP [m] β^*	0.5	0.5	0.25	0.25	May 2003
crossing angle	300	315	485	1000	May 2000
θ [µrad]					
beam current	0.56	0.86	1.3,	1.0	
I_b [A]			1.3		
luminosity $L [10^{34}]$	1	2.3	7.3,	9.0	A luminosity of
$cm^{-2}s^{-1}$]			9.7		$ 10^{35} \text{cm}^{-2} \text{ s}^{-1}$
σ_{δ} IBS growth time	134	86	56,	1712	seems possible
$ au_{\rm IBS}$ [h]			674		

(*) Superbunch: 1 bunch of 75 m (rms) in each ring Good for electron cloud effects/bad for experiments: 50000 events/25 ns slice

LHC luminosity upgrade: the LARP perspective

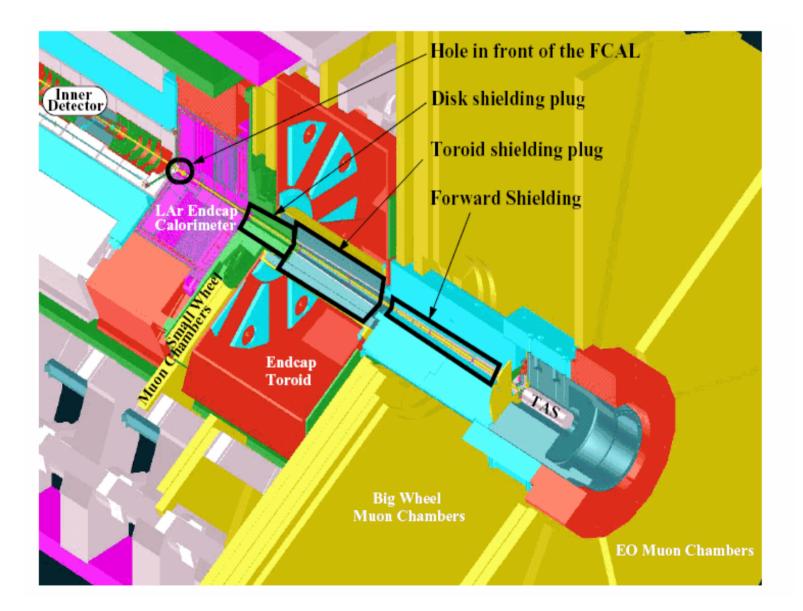


Courtesy of V. Shiltsev - FNAL

Basic Ingredients

- Bunch spacing or bunch frequency
- Number of protons/bunch
- Bunch length, bunch profile
- Emittance
- Crossing angle
- ß* i.e ß at the IP
- L* i.e distance between IP and the starting point of the inner triplet
- Aperture, gradient and length of the inner triplet (also technology NbTi/NbSn)
- IP layout i.e dipole or quadrupole first
- Early separation schemes D0 inside ATLAS
- Crab cavities
- Slim quadrupoles (Q0) to modify the behaviour of ß inside the experiment
- Wire compensation for long range beam-beam compensation Some of these ingredients only works in combination with others and some are independent

Slim magnets inside ATLAS



parameter	symbol	ultimate	25 ns, smaller β^{\star}	25 ms, large &	50 ns, long
transverse emittance	ε [μm]	3.75	3.75	7.5	3.75
protons per bunch	N _b [1011]	1.7	1.7	3.4	4.9
bunch spacing	Δt [ns]	25	25		50
beam current	I[A]	0.86	0.86	1.72	1.22
longitudinal profile 👔	171270	Gauss	Gauss	Gauss	Flat
rms bunch length	σ _g [cm]	7.55	7.55	3.78	14.4
beta* at IP1&5	β* [m] 🦲	0.5	0.08	0.25	0.25
full crossing angle	θ _e [murad]	315	100	639	381
Piwinski parameter 🛛 👔	3. 1 3. 15	0.75	0.60	0.64	2.5
peak luminosity	L [10 ³⁴ cm ⁻² 5 ⁻¹]	2.3	15.5	9.7	8.9
events per crossing		44	296		340
initial lumi lifetime	τ _լ [h]	14	2.1	6.8	5.3
effective luminosity	$L_{\rm eff}[10^{34}{\rm cm}^{-2}{\rm s}^{-1}]$	0.91	2.4	2.7	2.3
(T _{ternsround} =10 h)	T _{ren,opt} [h]	17.0	6.5	12.0	10.3
effective luminosity	$L_{\rm eff}[10^{34}{\rm cm}^{-2}{\rm s}^{-1}]$	1.15	3.6	3.6	3.1
(T _{turnaround} =5 h)	T _{run,opt} [h]	12.0	4.6	8.5	7.3
e-c heat SEY=1.4(1.3)	P [W/m]	1.04 (0.59)	1.04 (0.59)	2.56 (2.1)	0.36 (0.1)
SR heat load 4.6-20 K	P _{sr.} [W/m]	0.25	0.25	0.5	0.36
image current heat	P _{IC} [W/m]	0.33	0.33	3.74	0.78
gas-s. 100 h (10 h) τ _b	P _{gss} [W/m]	0.06 (0.56)	0.06 (0.56)	0.11 (1.13)	0.09 (0.9)
comment			D0 + crab	wire comp.	wire comp.
new upgrade parameters					

Hardware needed for these two scenarios

- 25 ns small ß (8 cm)
 - New triplet with bigger aperture (L* =23m)
 - Small angle crab cavity (~100 m from IP)
 - D0 needed
 - If NbTi technology Qo is needed
 - If Nb₃Sn technology no Qo needed
- 50 ns long bunch
 - New triplet with bigger aperture (L*=23 m)
 - No D0 needed
 - Both NbTi and Nb₃Sn possible without need for Qo
 - Wire compensation needed (~100 m from IP)

Relevant parameters for two scenarios

	25 ns small ß	50 ns long	buncl
 Bunch spacing 	: 25 ns	50 ns	
 Rms bunch len 	gth: 7.55 cm	14.4 cm	
 Long. Profile: 	Gauss	Flat	
 Luminous regional 	on: 2.5 cm	3.5 cm	
– Peak lumi:	15.5 10 ³⁴	8.9 10 ³⁴	
 Events crossing 	g: 296	340	
 Lumi. Life time: 	: 2.1 h	5.3 h	
– Effective lumi :	2.4 10 ³⁴	2.3 10 ³⁴	
 (10 h turn are 	/		
– Effective lumi:	3.6 10 ³⁴	3.1 10 ³⁴	
(5 h turn aro	und)		

zoom on decay time & integrated luminosity for various options

parameter	symbol	nominal	ultimate	12.5 ns	25 ns, smaller β^\star	50 ns, long
max. # events / crossing		19	44	88	296	340
peak luminosity	L [1e34 cm-2s-1]	1	2.3	9.2	14.4	8.9
effective beam decay time	τ _{eff} [h]	45	29	14.4	4.6	10.7
effective	L _{eff} [10 ³⁴ cm ⁻² s ⁻¹]	0.46	0.91	2.7	2.4	2.3
luminosity (T _{turnaround} =10 h)	T _{run,opt} [h]	21.2	17.0	12.0	6.5	10.3
effective	L _{eff} [10 ³⁴ cm ⁻² s ⁻¹]	0.56	1.15	3.6	3.6	3.1
luminosity (T _{turnaround} =5 h)	T _{ryn,opt} [h]	15.0	12.0	8.5	4.6	7.3
Aver	age ev	ents/b	с		1	50 208

Heat load

zoom on heat load

parameter	symbol	nominal	ultimate	12.5 ns	25 ns, smaller β^*	50 ns, long
SR heat load 4.6-20 K	P _{sR} [W/m]	0.17	0.25	0.5	0.25	0.36
image current heat	P _{ic} [W/m]	0.15	0.33	1.87	0.33	0.78
total BS heat load w/o e-cloud	P _{sr} + P _{ic} [W/m]	0.32	0.58	2.37	0.58	1.14
local cooling limit*	P _{oool} [W/m]	2.4	2.4	2.4	2.4	2.4
cooling remaining for e- cloud	P cool, rest [W/m]	2.08	1.82	0.03	1.82	1.26
simulated e-c heat for SEY=1.4 (1.3)	P [W/m]	1.07 (0.44)	1.04 (0.6)	13.34 (7.85)	1.04 (0.59)	0.36 (0.1)
* L. Tavian, LUN	* L. Tavian, LUMI'06 Not OK					

feasible

LHC energy doubler 14*14 TeV

- ☆ dipole field B_{nom} = 16.8 T, B_{design} = 18.5-19.3 T (10-15% margin)
 - o superconductor Nb₃Sn
 - o 10-13 T field demonstrated in several 1-m long Nb3Sn dipole models
 - DLHC magnet parameters well above the demonstrated Nb3Sn magnet technology
- R&D and construction time and cost estimates
 - o 10+ years for magnet technology development and demonstration o Magnet production by industry ~ 8-10 years
 - o High cost for R&D and construction (cost of dipoles > 3GCHF ?)

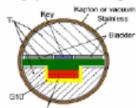
LHC Energy Upgrade

Design Features & Applications

- Target field 15 Tesla
- Clear bore 36 mm
- · Simple coil configuration
- · Designed for high field quality
- Suitable for HF cable testing
- · Compatible with HTS inserts

4.5 K Short Sample Parameters

Parameter	Unit	HD1	HD2
Clear bore	mm.	8	- 36
Coil field	Tesla	-16.1	15.8
Bore field	Tesla	-16.7	-15.0
Max current	kA	11.4	17.3
Stored Energy	- MJ/m	0.66	0.84
F _a (quadrant, 1ap)	MN/m	4.7	5.6
F _y (quadrant, 1ap	MN/m	-1.5	-2.6
Ave. stress (h)	MPa	150	150

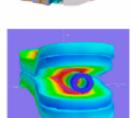


High-field cable testing

Cable x 2



2-layer winding without spacers in body or ends

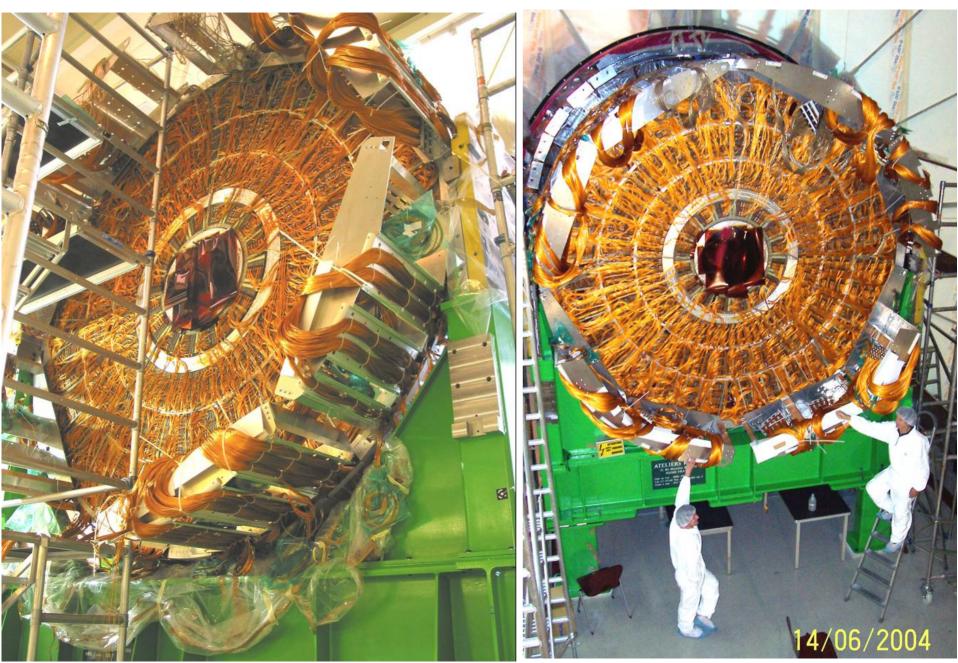


LHC energy tripler 21*21 TeV

- ✤ dipole field B_{nom} = 25 T, B_{design} = 28-29 T (10-15% margin)
 - o superconductor HTS-BSCCO (low demand) or Nb3Sn
 - o Magnet technology to be fully demonstrated
 - DLHC magnet parameters well above the demonstrated Nb3Sn magnet technology
- Large aperture dipole to accommodate an efficient beam screen
- R&D and construction time and cost/risk estimates
 - o 20++ years for magnet technology development and demonstration
 - o Extremely high R&D and construction cost and risk
 - SC cable to be developed,
 - Magnetic coil stress requires innovative dipole cross section
 - o Magnet production by industry (?) ?? years

SLHC Physics Extras

EM EndCap A wheel on the insertion stand, May - June 2004



LAr Forward Calorimeters

• C end in Cryostat

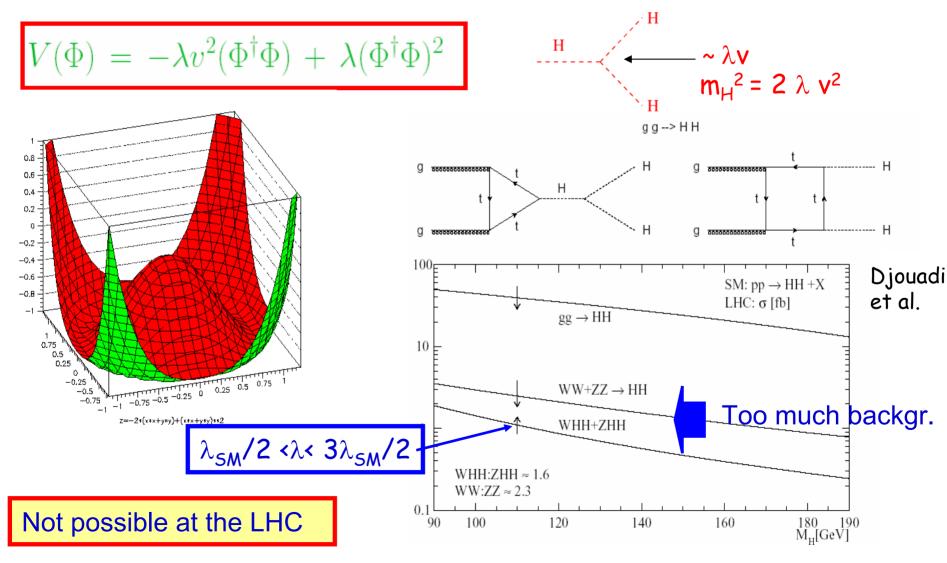
• A end assembled into support tube



• FCAL C assembly into tube – Fall 2003

Higgs Self Coupling Measurements

Once the Higgs particle is found, try to reconstruct the Higgs potential



Higgs Self Couplings

LHC : σ (pp \rightarrow HH) < 40 fb m_H > 110 GeV + small BR for clean final states \rightarrow **no sensitivity**

SLHC : $HH \rightarrow W^+ W^- W^+ W^- \rightarrow \ell^{\pm} \nu j j \ell^{\pm} \nu j j$

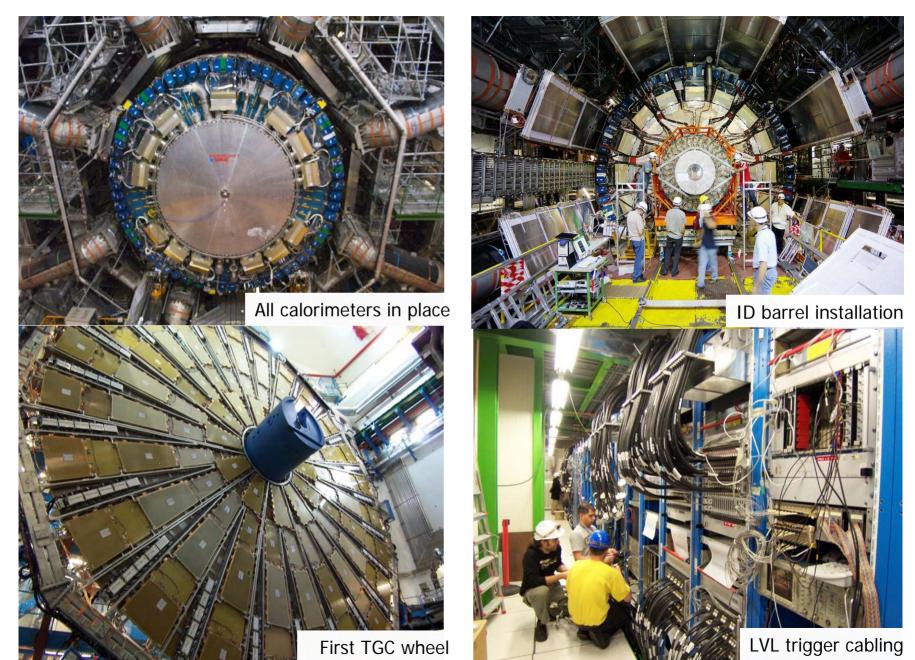
studied (very preliminary)

6000 fb ⁻¹	S	S/B	S/√B
m _H = 170 GeV	350	8%	5.4
m _H = 200 GeV	220	7%	3.8

-- HH production may be observed first at SLHC: ~150 <M_H<200 GeV -- λ may be measured with statistical error ~ 20-25%

LC : precision up to 20-25% but for $M_{H} < 150 \text{ GeV}$ ($\sqrt{s} \ge 500-800 \text{ GeV}$, 1000 fb⁻¹)

ATLAS Detector construction in UX15



Diamond Pixel Sensor EOI

- Submitted early May
- Institutions:
 - Bonn
 - Carleton
 - CERN
 - Ljubljana
 - Ohio State
 - Toronto
- Review/approval in summer/fall

	Diamond Pixel Modules for the High Luminosity ATLAS Inner Detector Upgrade				
ATLAS					
ATLAS Upgrade Document No:	Institute Document No. Created: 11/05/2007 Page: 1 of 12		Page: 1 of 12		
	Modified: Rev. No.: 1.0		Rev. No.: 1.0		

Abstract

The goal of this proposal is the development of diamond pixel modules as an option for the ATLAS pixel detector upgrade. This proposal is made possible by progress in three areas: the recent reproducible production of high quality diamond material in wafers, the successful completion and test of the first diamond ATLAS pixel module, and the operation of a diamond after irradiation to 1.8×10^{16} p/cm². In this proposal we outline the results in these three areas and propose a plan to build and characterize a number of diamond ATLAS pixel modules, test their radiation hardness, explore the cooling advantages made available by the high thermal conductivity of diamond and demonstrate industrial viability of bump-bonding of diamond pixel modules.

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